



PBSS4420D-Q

20 V, 4 A NPN low V_{CEsat} transistor

22 September 2023

Product data sheet

1. General description

NPN low V_{CEsat} transistor in a small SOT457 (SC-74) Surface-Mounted Device (SMD) plastic package.

PNP complement: PBSS5420D

2. Features and benefits

- Very low collector-emitter saturation resistance
- Ultra low collector-emitter saturation voltage
- 4 A continuous collector current
- Up to 15 A peak current
- High efficiency due to less heat generation
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- Power management functions
- Charging circuits
- DC-to-DC conversion
- MOSFET gate driving
- Power switches (e.g. motors, fans)
- Thin Film Transistor (TFT) backlight inverter

4. Quick reference data

Table 1. Quick reference data

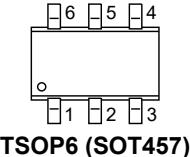
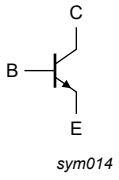
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V _{CEO}	collector-emitter voltage	open base		-	-	20	V
I _C	collector current		[1]	-	-	4	A
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-	15	A
R _{CEsat}	collector-emitter saturation resistance	I _C = 4 A; I _B = 400 mA; pulsed; t _p ≤ 300 µs; δ ≤ 0.02; T _{amb} = 25 °C		-	50	70	mΩ

[1] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

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5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	C	collector	 TSOP6 (SOT457)	 sym014
2	C	collector		
3	B	base		
4	E	emitter		
5	C	collector		
6	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PBSS4420D-Q	TSOP6	plastic, surface-mounted package (SC-74; TSOP6); 6 leads	SOT457

7. Marking

Table 4. Marking codes

Type number	Marking code
PBSS4420D-Q	D4

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter		-	20	V
V_{CEO}	collector-emitter voltage	open base		-	20	V
V_{EBO}	emitter-base voltage	open collector		-	5	V
I_C	collector current		[1]	-	4	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1$ ms		-	15	A
I_B	base current			-	0.8	A
I_{BM}	peak base current	single pulse; $t_p \leq 1$ ms		-	2	A
P_{tot}	total power dissipation	$T_{amb} \leq 25$ °C	[2]	-	360	mW
			[3]	-	600	mW
			[4]	-	750	mW
			[1]	-	1.1	W
			[2] [5]	-	2.5	W
T_j	junction temperature			-	150	°C
T_{amb}	ambient temperature			-65	150	°C
T_{stg}	storage temperature			-65	150	°C

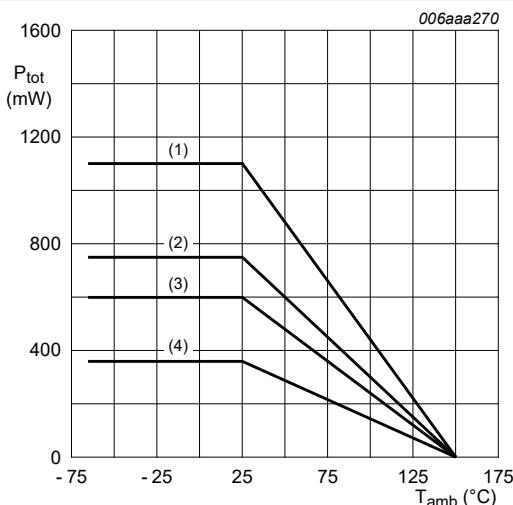
[1] Device mounted on a ceramic PCB, Al_2O_3 , standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm^2 .

[4] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm^2 .

[5] Operated under pulsed conditions: $\delta \leq 10\%$; $t_p \leq 10$ ms.



(1) Ceramic PCB, Al_2O_3 , standard footprint

(2) FR4 PCB, mounting pad for collector 6 cm^2

(3) FR4 PCB, mounting pad for collector 1 cm^2

(4) FR4 PCB, standard footprint

Fig. 1. Power derating curves

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	350	K/W
			[2]	-	-	208	K/W
			[3]	-	-	160	K/W
			[4]	-	-	113	K/W
			[1] [5]	-	-	50	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	-	45	K/W

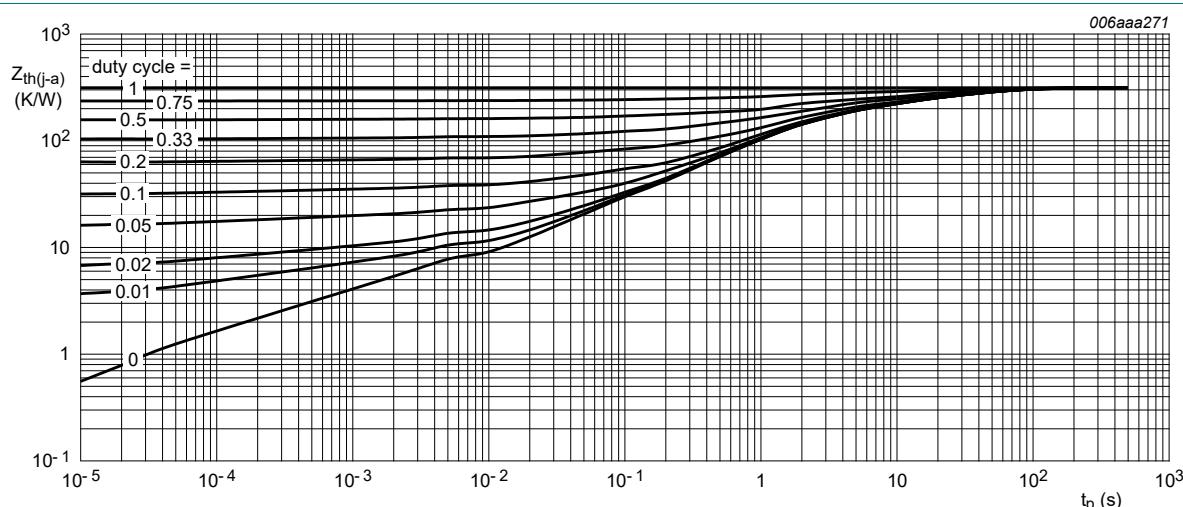
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm².

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm².

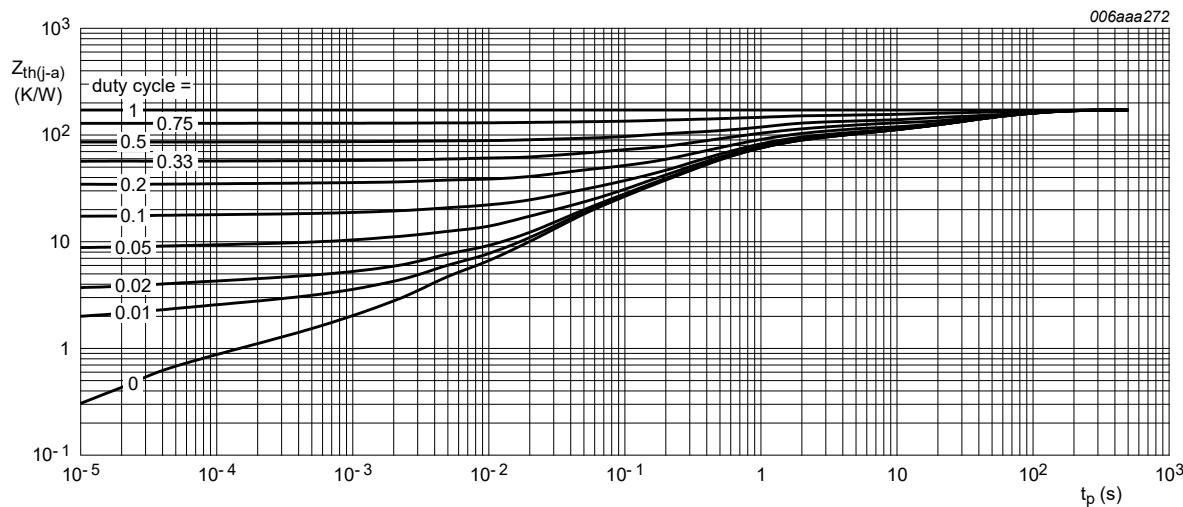
[4] Device mounted on a ceramic PCB, Al₂O₃, standard footprint.

[5] Operated under pulsed conditions: $\delta \leq 10\%$; $t_p \leq 10$ ms.



FR4 PCB, standard footprint

Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for collector 1 cm²

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

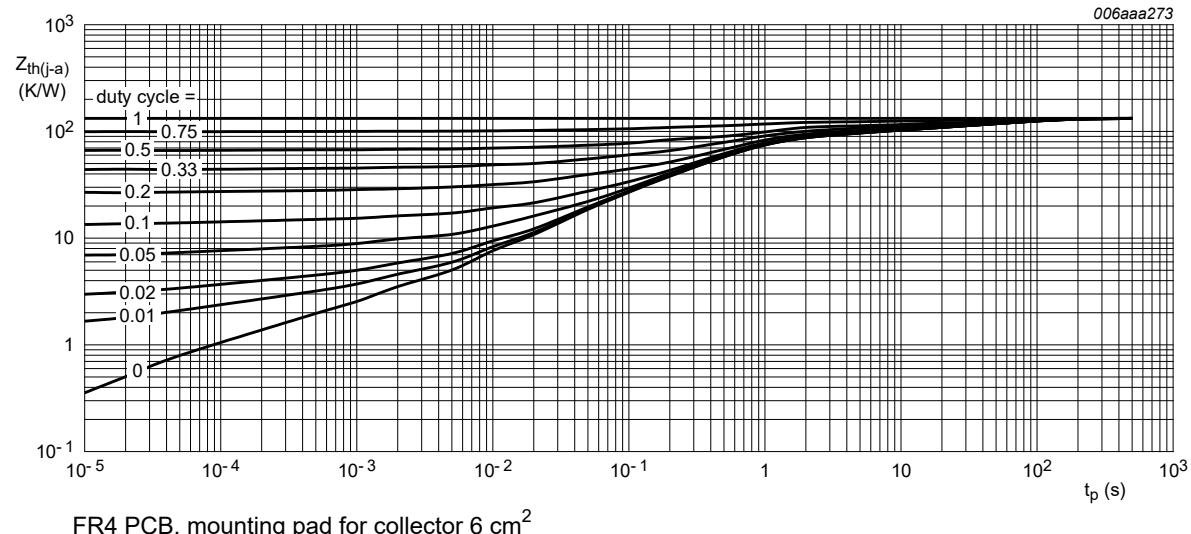


Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
I_{CBO}	collector-base cut-off current	$V_{CB} = 20 \text{ V}; I_E = 0 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	-	100	nA
		$V_{CB} = 20 \text{ V}; I_E = 0 \text{ A}; T_j = 150 \text{ }^\circ\text{C}$	-	-	50	µA
I_{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	-	100	nA
I_{CES}	collector-emitter cut-off current	$V_{CE} = 20 \text{ V}; V_{BE} = 0 \text{ V}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	-	100	nA
h_{FE}	DC current gain	$V_{CE} = 2 \text{ V}; I_C = 0.5 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$	300	450	-	
		$V_{CE} = 2 \text{ V}; I_C = 1 \text{ A}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	300	430	-	
		$V_{CE} = 2 \text{ V}; I_C = 2 \text{ A}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	250	400	-	
		$V_{CE} = 2 \text{ V}; I_C = 4 \text{ A}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	200	310	-	
		$V_{CE} = 2 \text{ V}; I_C = 6 \text{ A}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	100	230	-	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 0.5 \text{ A}; I_B = 50 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	30	50	mV
		$I_C = 1 \text{ A}; I_B = 50 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	60	90	mV
		$I_C = 2 \text{ A}; I_B = 200 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	110	150	mV
		$I_C = 4 \text{ A}; I_B = 400 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	-	200	280	mV
		$I_C = 6 \text{ A}; I_B = 600 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	-	300	420	mV
R_{CEsat}	collector-emitter saturation resistance	$I_C = 4 \text{ A}; I_B = 400 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	-	50	70	mΩ
V_{BEsat}	base-emitter saturation voltage	$I_C = 0.5 \text{ A}; I_B = 50 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	0.79	0.85	V
		$I_C = 1 \text{ A}; I_B = 50 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	0.81	0.9	V
		$I_C = 1 \text{ A}; I_B = 100 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	-	0.83	1	V
		$I_C = 4 \text{ A}; I_B = 400 \text{ mA}; \text{pulsed}; t_p \leq 300 \text{ } \mu\text{s}; \delta \leq 0.02; T_{amb} = 25 \text{ }^\circ\text{C}$	-	1	1.1	V
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = 2 \text{ V}; I_C = 2 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	0.79	1	V
t_d	delay time	$V_{CC} = 12.5 \text{ V}; I_C = 3 \text{ A}; I_{BON} = 0.15 \text{ A}; I_{BOFF} = -0.15 \text{ A}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	12	-	ns
t_r	rise time		-	36	-	ns
t_{on}	turn-on time		-	48	-	ns
t_s	storage time		-	230	-	ns
t_f	fall time		-	50	-	ns
t_{off}	turn-off time		-	280	-	ns
f_T	transition frequency	$V_{CE} = 10 \text{ V}; I_C = 0.1 \text{ A}; f = 100 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	100	-	MHz
C_c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = 0 \text{ A}; i_e = 0 \text{ A}; f = 1 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C}$	-	60	-	pF

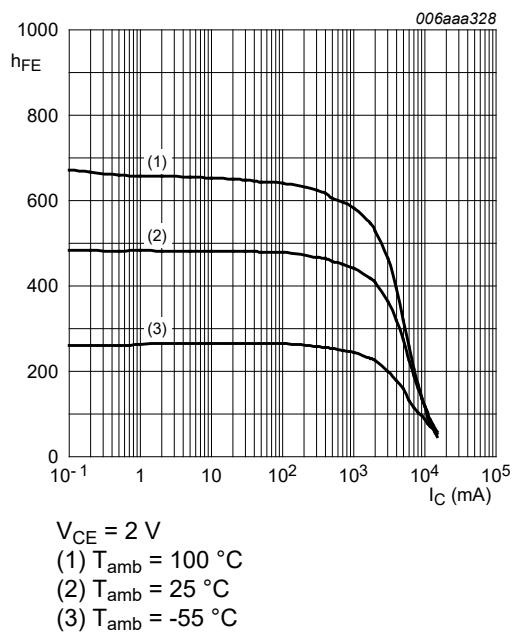


Fig. 5. DC current gain as a function of collector current; typical values

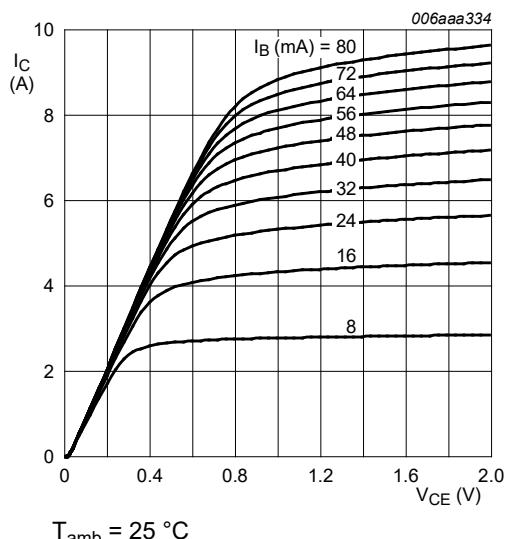


Fig. 6. Collector current as a function of collector-emitter voltage; typical values

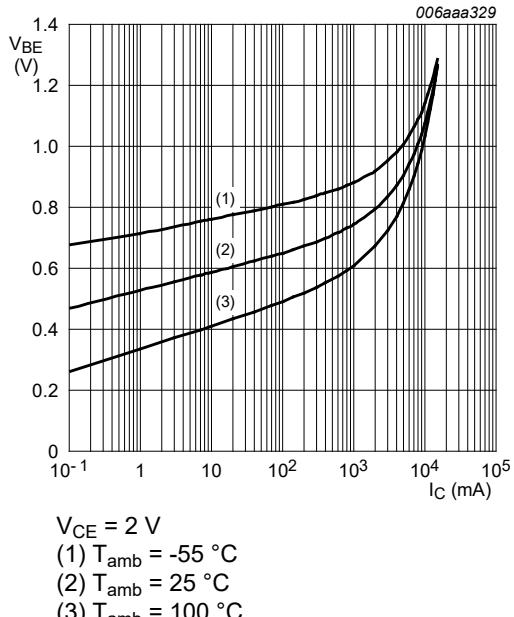


Fig. 7. Base-emitter voltage as a function of collector current; typical values

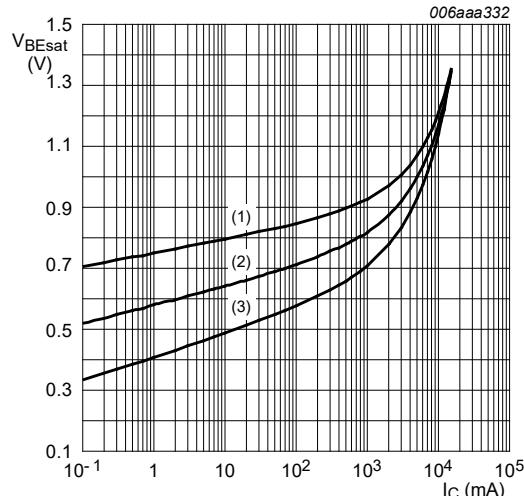
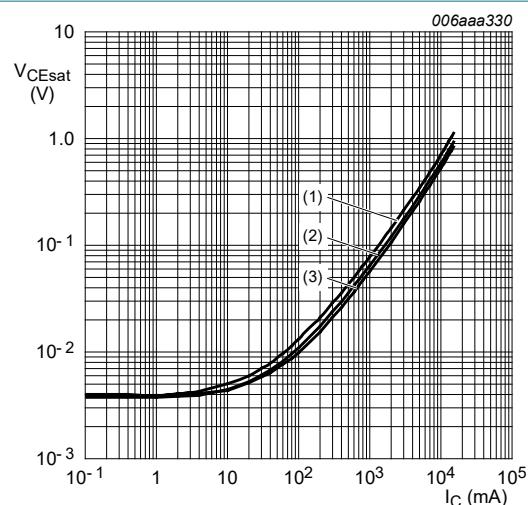
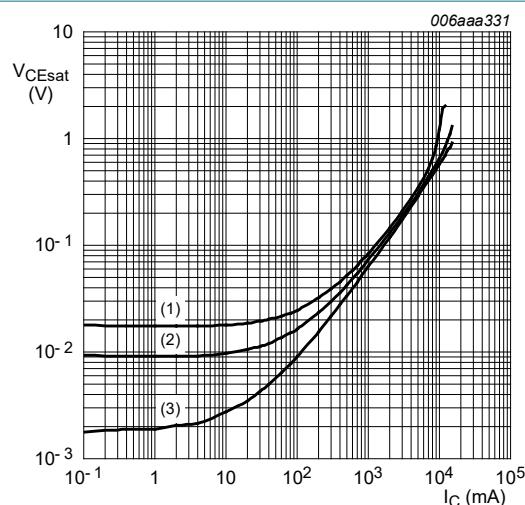


Fig. 8. Base-emitter saturation voltage as a function of collector current; typical values



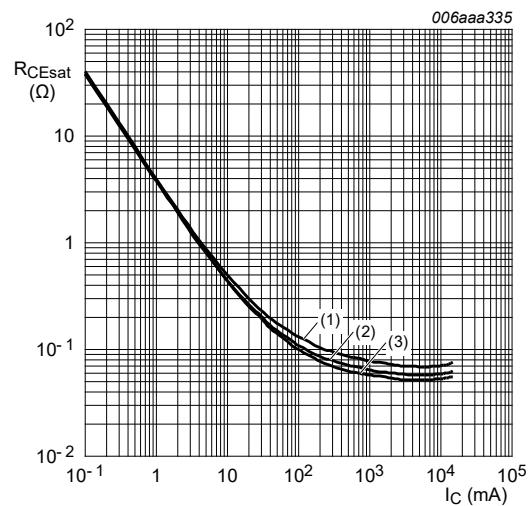
$I_C/I_B = 20$
 (1) $T_{amb} = 100^\circ C$
 (2) $T_{amb} = 25^\circ C$
 (3) $T_{amb} = -55^\circ C$

Fig. 9. Collector-emitter saturation voltage as a function of collector current; typical values



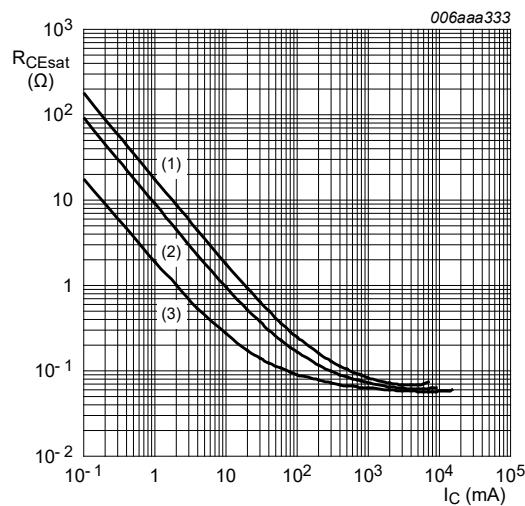
$T_{amb} = 25^\circ C$
 (1) $I_C/I_B = 100$
 (2) $I_C/I_B = 50$
 (3) $I_C/I_B = 10$

Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values



$I_C/I_B = 20$
 (1) $T_{amb} = 100^\circ C$
 (2) $T_{amb} = 25^\circ C$
 (3) $T_{amb} = -55^\circ C$

Fig. 11. Collector-emitter saturation resistance as a function of collector current; typical values



$T_{amb} = 25^\circ C$
 (1) $I_C/I_B = 100$
 (2) $I_C/I_B = 50$
 (3) $I_C/I_B = 10$

Fig. 12. Collector-emitter saturation resistance as a function of collector current; typical values

11. Test information

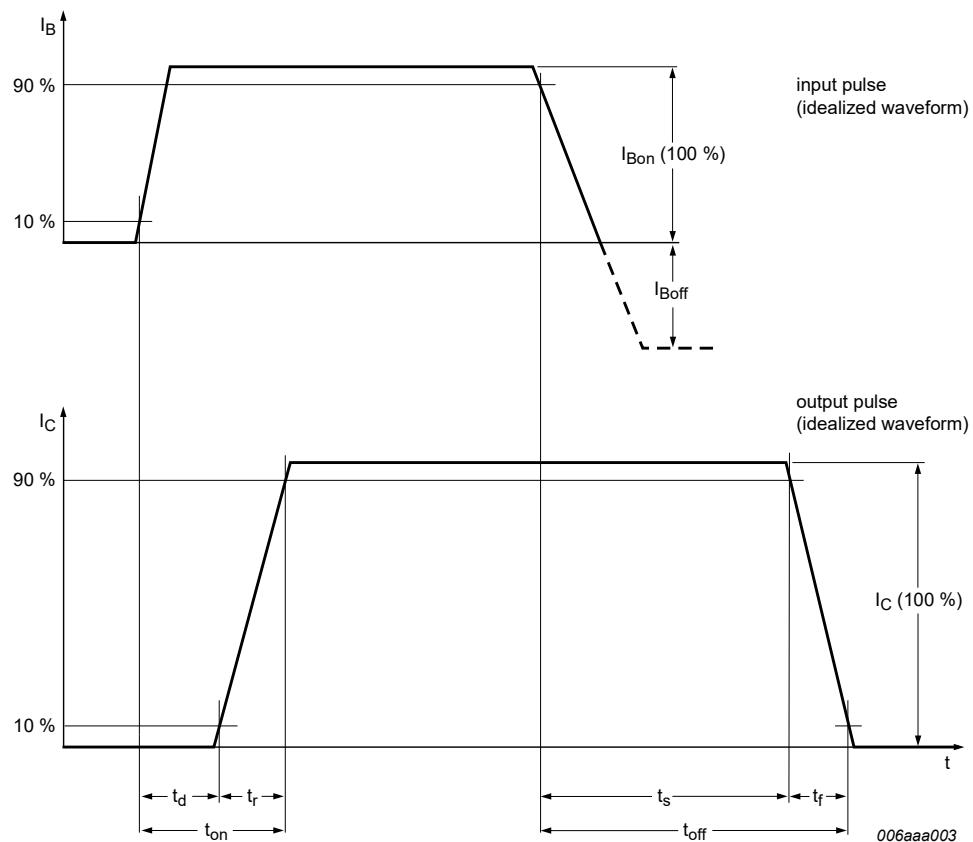


Fig. 13. Switching time definition

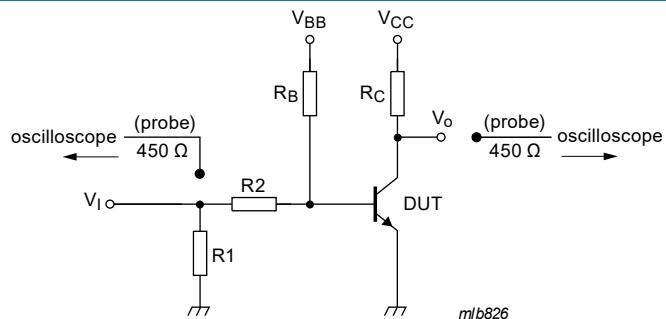


Fig. 14. Test circuit for switching times

$V_{CC} = 12.5 \text{ V}$; $I_C = 3 \text{ A}$; $I_{Bon} = 0.15 \text{ A}$; $I_{Boff} = -0.15 \text{ A}$

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

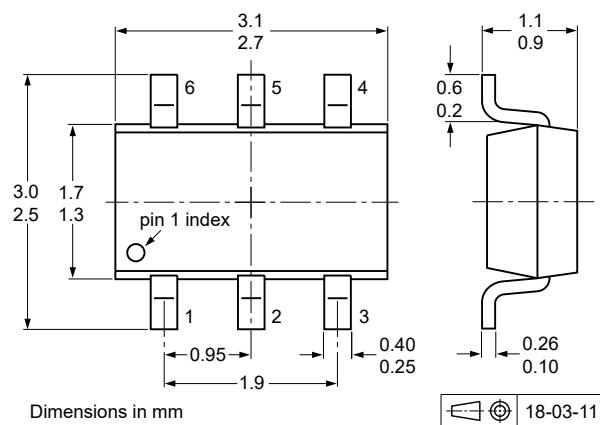


Fig. 15. Package outline TSOP6 (SOT457)

13. Soldering

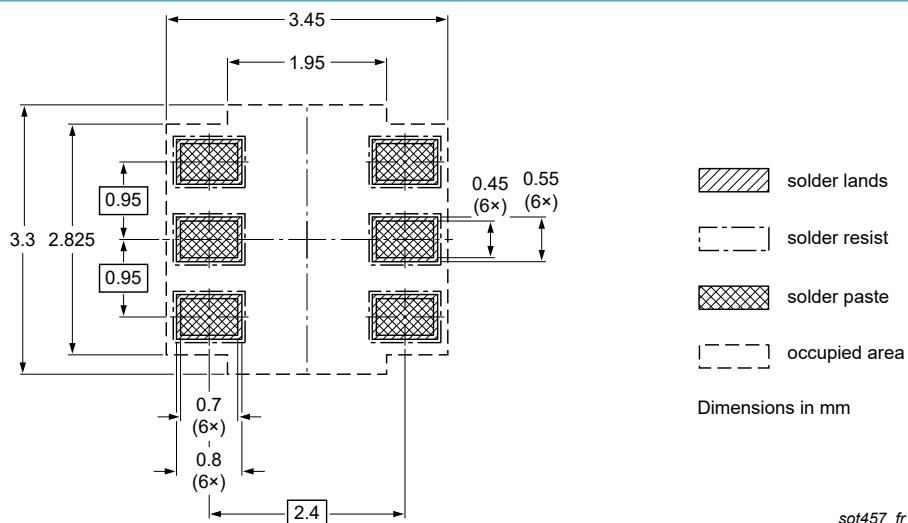


Fig. 16. Reflow soldering footprint for TSOP6 (SOT457)

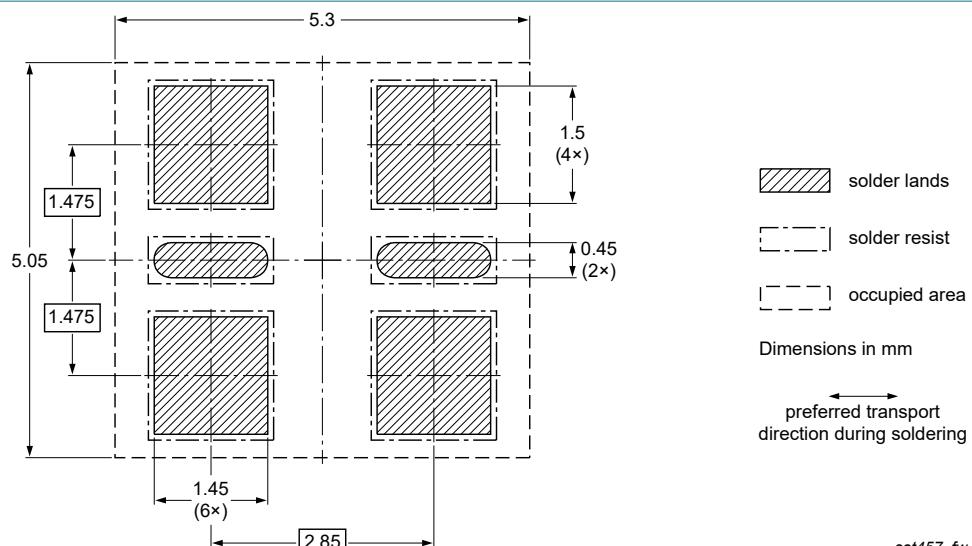


Fig. 17. Wave soldering footprint for TSOP6 (SOT457)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4420D-Q v.1	20230922	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 22 September 2023
